

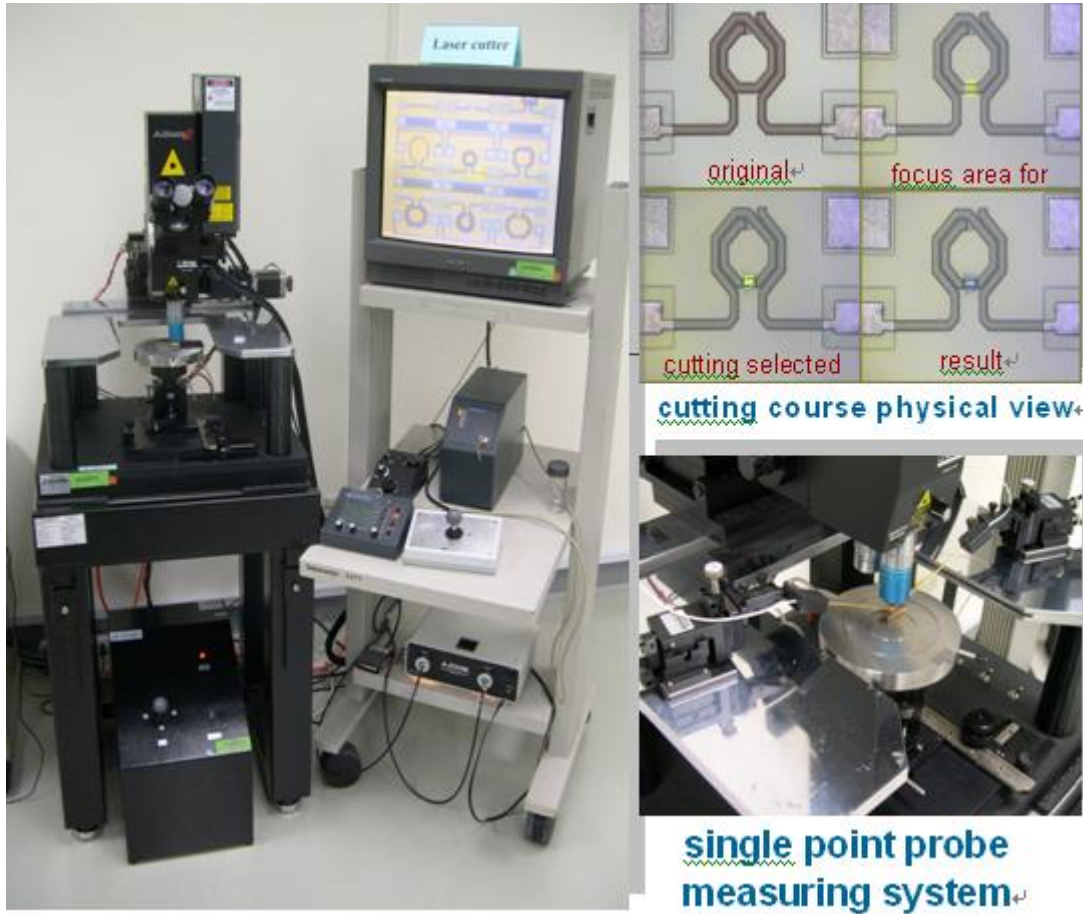
# 雷射切割系統

## Laser cutter

### 系統簡介:

利用雷射(UV 或 Green)提供電路進行 Layout 除錯  
提供晶片 PAD 欲清除之 passivation

### 儀器圖片:



### 儀器規格型號:

1. New Wave Laser

2. A-ZOOM Optical microscope zoom
3. Possess Green and UV (532nm and 355nm)double- ray long laser
4. Minimum cutting range is  $2\mu\text{m} \times 2\mu\text{m}$
5. Maximum cutting range is  $40\mu\text{m} \times 40\mu\text{m}$
6. Optical microscope zoom: 10x objective zoom: 2x , 50x , 100x

**服務項目:**

1. Layout 除錯
2. PAD 欲清除之 passivation

**注意事項:**

無

**儀器維護者:**

張小姐 035773963#7192 [henzu@narlabs.org.tw](mailto:henzu@narlabs.org.tw)